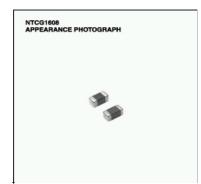
NTC Chip Thermistor
NTCG Series
608 Type
NTCG164LH104HT1

Product Lifecycle Stage	PROD
Release Date	2000/10/01
Based on the Standard	JIS C 2570



Specification

Mounting Method Flag	No		
Туре	Chip Type		
Size Code	1608		
Body Length(L)	Nom	1.6 m	m
Body Breadth(W)	Nom	0.8 m	m
Body Height(T)	Nom	0.8 m	m
Rated ZerePower Resistanc	Тур	100 k	Ohm
Rated ZerePower Tolerance	+/-3%		
Rated BValue(B25/85)	Тур	4550	K
Rated BValue(B25/50)	Тур	4485	K
Tolerance of Rated-⊮alue	+/-3%		
Maximum Power Dissipatior	230 m	W	
Soldering Method	Reflow		
Category Temperature Ran	Min	-40	Cel
	Max	125	Cel
Storage Temperature Range	Min	-40	Cel
	Max	125	Cel
Weight	Nom	0.005	g

Summary/Applications/Features						
Summary	A size of L1.6xW0.8xT0.8mm.It can choose from wide r resistance series.From 30ohms to 1Mohm.					
Applications	CELLULAR,PC,ODD,BATTERY,LCD,PRINTER,HDD,B STATION,POWER AMP					
Features	This product include no lead and applies to the EU Could Directive 2002/95/EC RoHS. This product realized excellent solderablity and solderin heat resistance, comparing with the conventional eutect mixture solder and leadee solder (Sn/Ag/Cu, etc.). The 0603, 1608 and 1005 types provide 3 different shar with identical resistanceemperature characteristics. By using layered internal electrode structure, product series provides a wide range of resistance constants and realized good stability of resistance value after soldering.					
Packaging						
Packing			Punched (Paper)Taping [180mm Reel]			
Minumum Pa	ackage Qty	Nom	400C Pcs			
Minimum Or	Minimum Order Qty Nom		4000 Pcs			



Details

[Caution]

Specifications which provide more details for the proper and safe use of the described product are available upon request.

[Notice of Revision and Improve]

All specifications are subject to change without notice.